Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	("20030174478").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR .	OFF	2007/01/04 12:44
L2	2858	(29/832).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L3	120087	"439"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	OFF	2007/01/04 14:48
L4	887	L3 and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L5	799	L4 and (substrate board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L6	3126	L3 and (emi (electromagnetic adj interference))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L7	80	L6 and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L8	3160	L3 and (emi (faraday adj cage) (electromagnetic adj interference))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48

L9	82	L8 and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L10	2498	(361/760,762,764).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L11	1941	(257/777).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L12	803	(L10 L2 L11) and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L13	779	L12 and (substrate board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR :	OFF	2007/01/04 14:48
L14	2944	(361/704).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L15	1235	L14 and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48
L16	106	L15 and (emi (faraday adj cage) (electromagnetic adj interference))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/04 14:48

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S1	2454	(361/760,762,764).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:49
S2	2761	(29/832).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:49
S3	1837	(257/777).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:49
S4	117902	"439"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:50
S5	858	S4 and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:53
S6	771	S5 and (substrate board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:51
S7	771	(S1 S2 S3) and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:51
S8	747	S7 and (substrate board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:52

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S9	2965	S4 and (emi (electromagnetic adj interference))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:54
S10	<b>75</b>	S9 and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:54
S11	2997	S4 and (emi (faraday adj cage) (electromagnetic adj interference))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:55
S12	77	S11 and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:55
S13	2801	(361/704).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:55
S14	1186	S13 and (sink spreader) and ((integrated adj circuit) die chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:55
S15	102	S14 and (emi (faraday adj cage) (electromagnetic adj interference))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/04 13:55